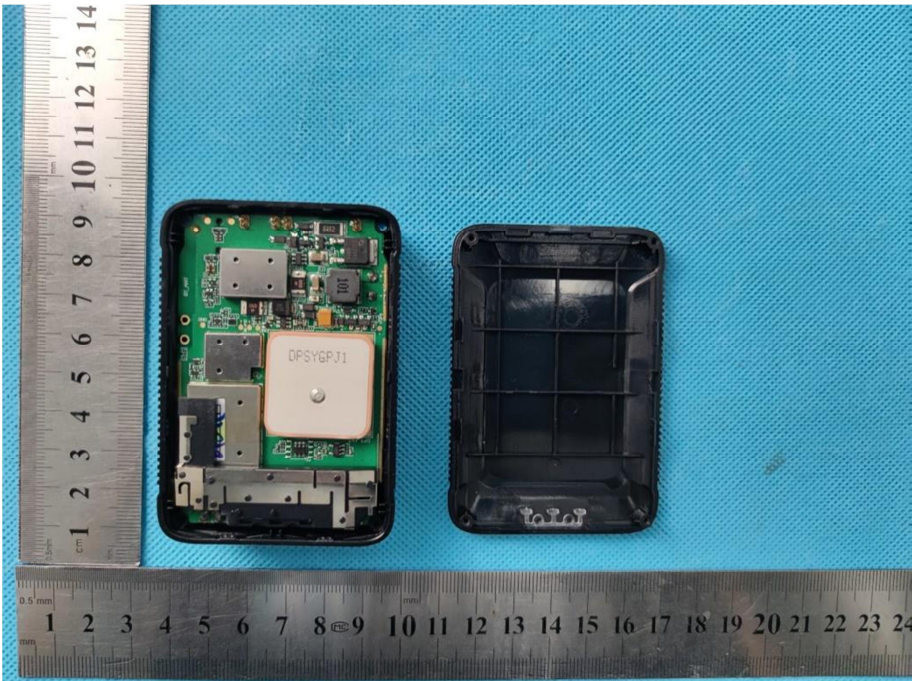
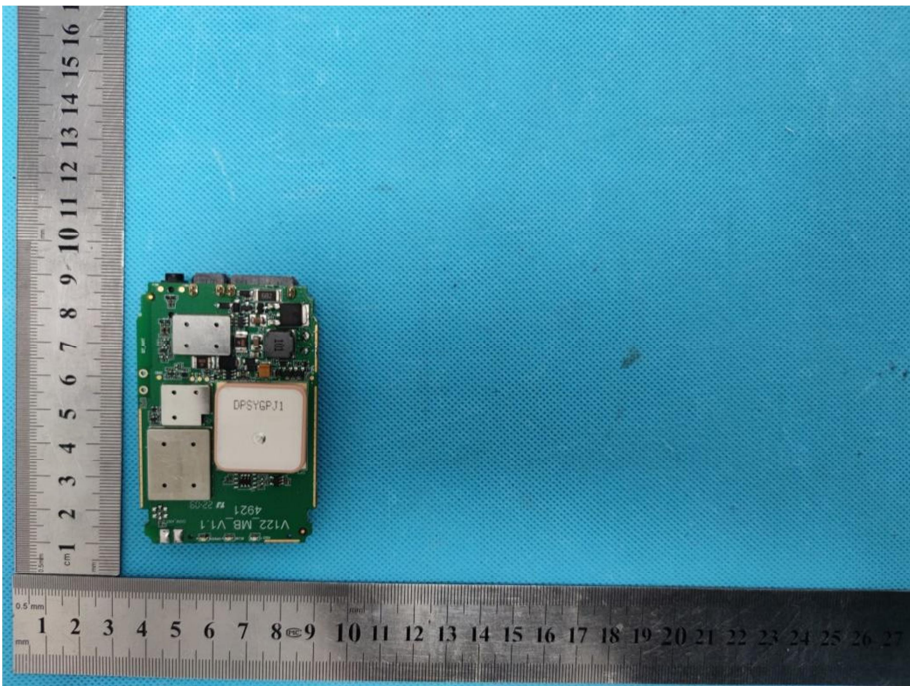


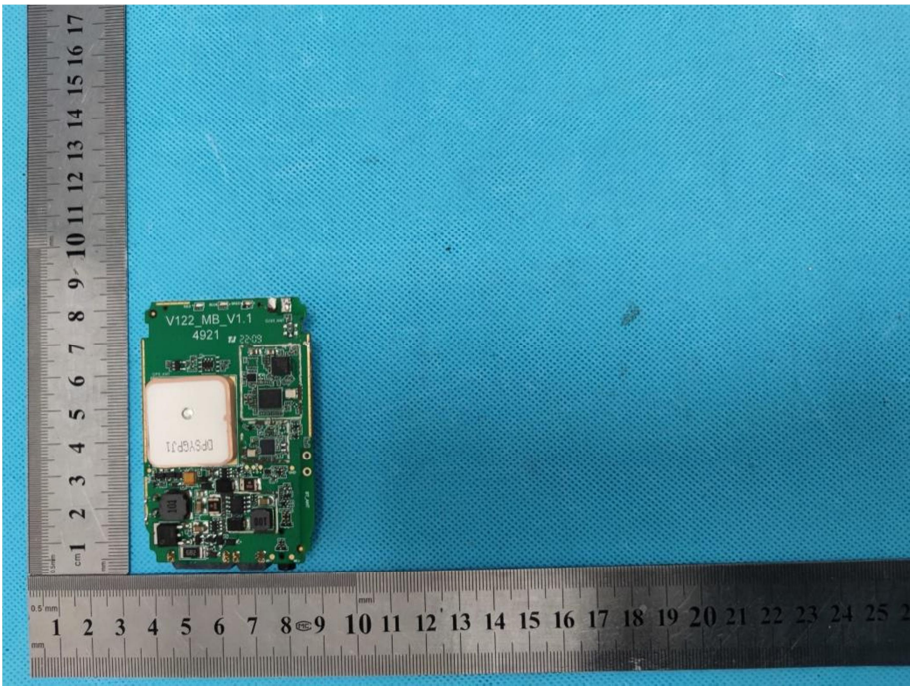
EXHIBIT 3 - EUT INTERNAL PHOTOGRAPHS

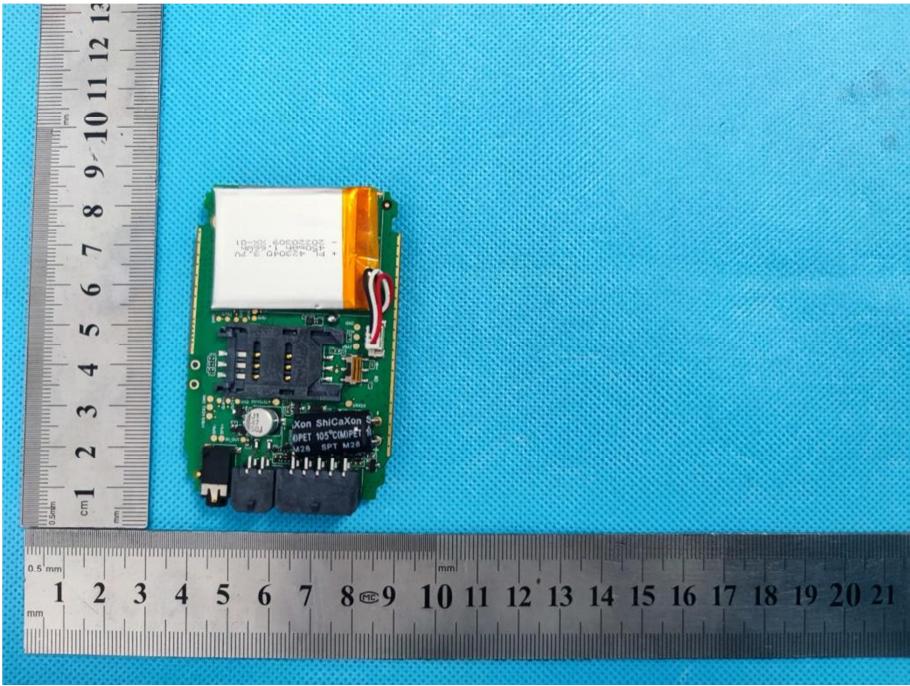
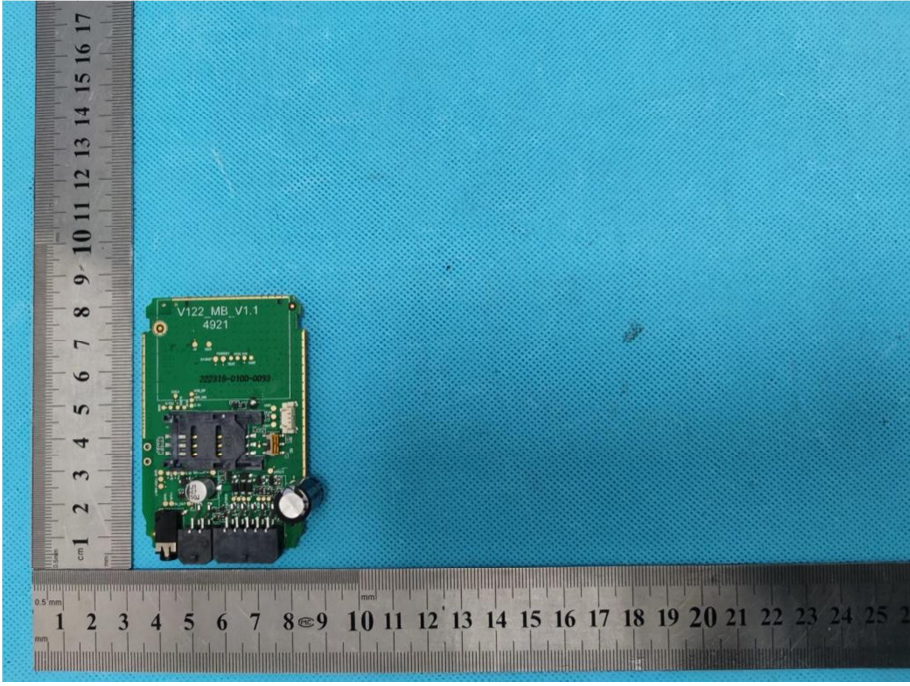
EUT Housing and Board View 1	 A photograph showing the back of a black plastic EUT housing and a small black component. A ruler is placed vertically on the left and horizontally at the bottom for scale. The housing has a white label with the following text: X3-MN, IMEI: 865120960000110, FCCID: 2ABLFJW-A3-MN, Made in China.
EUT Housing and Board View 2	 A photograph showing the front of the EUT housing and the internal circuit board. The board is green and populated with various components, including a large silver component labeled DPSYGPJ1. The black plastic housing is shown to the right. A ruler is placed vertically on the left and horizontally at the bottom for scale.

**Solder
Board-Component
View 1**



**Solder
Board-Component
View 2**



Solder Board-Component View 3	 A photograph of a green printed circuit board (PCB) component, labeled 'View 3', placed on a blue textured surface. The component is rectangular and features a white rectangular label at the top with the text '10-05-1000000000' and '10-05-1000000000'. Below the label, there are several black integrated circuits (ICs) and other electronic components. A ruler is positioned vertically to the left of the component, showing a scale from 1 to 13 cm. Another ruler is positioned horizontally below the component, showing a scale from 1 to 21 cm.
Solder Board-Component View 4	 A photograph of the same green printed circuit board (PCB) component, labeled 'View 4', placed on a blue textured surface. The component is rectangular and features a white rectangular label at the top with the text 'V122 MB V1.1' and '4921'. Below the label, there are several black integrated circuits (ICs) and other electronic components. A ruler is positioned vertically to the left of the component, showing a scale from 1 to 17 cm. Another ruler is positioned horizontally below the component, showing a scale from 1 to 25 cm.

Antenna View

